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|--|----------------------------|----|----------------|--|
|  | Filing Date                |    | 2006-04-04     |  |
|  | First Named Inventor Hidek |    | ekazu Michioka |  |
|  | Art Unit                   |    | 3656           |  |
| (Notion Submission under or or it 1.50)  | Examiner Name P. A.        |    | Johnson        |  |
|  | Attorney Docket Number     | er | 062329         |  |

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| Examiner Name          | P. A. Johnson |                   |  |  |  |
| Attorney Docket Number |               | 062329            |  |  |  |

|   | 4          | 4-19918   | JP | U     | 1992-02-19  | NSK, Ltd. | Concise explanation of relevance |  |  |
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